- RAFTX - 344	U.S. DEPARTMENT OF COMMERCE
SDE~958	101485410 Patent and Trademark Office
To the Honorable Commissioner of Patents and Trademark	ks: Please record the attached original documents or copy thereof.
1. Name of conveying party(ies) 1) Takashi IKENAGA Addit onal name(s) of conveying party(ies) attached No	2. Name and address of receiving party(ies) Name: SONY CORPORATION Internal Address:
3. Nature of conveyance:	Street Address: 7-35 Kitashinagawa 6-chome Shinagawa-ku
As signment	City: Tokyo, JAPAN
☐ Security Agreement ☐ Change of Name	Additional name(s) & address(es) attached ☐ Yes ☒ No
Other Execution Date: August 15, 2000 4. Application number(s) or patent number(s):	9/128780
If the document is being filed together with a new appl	ication, the execution date of the application is August 15, 2000 dditional numbers attached No
Name and address of party to whom correspondence co- document should be mailed:	
Name Monica Millner	7. Total fee (37 CFR 3.41) \$ 40.00 \$
Internal Address: RADER, FISHMAN & GRAUER Suite 501	Enclosed ☐ Enclosed ☐ Authorized to be charged to Deposit Account €
Street Address: 1233 20th Street, NW	8. Deposit account number: 18-0013 (Attach duplicate copy of this page if paying by deposit account)
City: Washington, D.C. Zip: 20036	(Attach duplicate copy of this page if paying 1)
9. Statement and signature.	g information is true and correct and any attached copy is a true copy of the original Signature Total number of pages comprising cover sheet

10/11/2000 ANHMED1 00000110 180013 29128780 01 FC:581 40.00 CH

> PATENT REEL: 011140 FRAME: 0876

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

CHARGER FOR COMPUTER

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35, Kitashinagawa 6-chome, Shinagawa-ku, Tokyo, JAPAN, (hereinafter referenced as ASSIGNEES) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of Ten Dollar (\$10.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEES, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEES, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEES or its designee, as ASSIGNEES or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

PATENT REEL: 011140 FRAME: 0877 And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEES will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number:______, Filing Date:______.

This assignment executed on the dates indicated below.

on the state of th	
Takashi IKENAGA Name of first inventor	Execution date of U.S. Patent Application
Name of first inventor	Execution date of over 1111
Tokyo, JAPAN	
Residence of first inventor	
Jakasha Jkiruga Signature of first inventor	Date of this assignment
Signature of first inventor	Date of this assignment
Name of second inventor	Execution date of U.S. Patent Application
Residence of second inventor	
	- f this assignment
Signature of second inventor	Date of this assignment

RECORDED: 08/31/2000

PATENT REEL: 011140 FRAME: 0878